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Details

Product Status	Active
Core Processor	PIC
Core Size	16-Bit
Speed	40 MIPS
Connectivity	I ² C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	35
Program Memory Size	16KB (5.5K x 24)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 13x10b/12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic24hj16gp304-e-pt

PIC24HJ32GP202/204 AND PIC24HJ16GP304

PIC24HJ32GP202/204 and PIC24HJ16GP304 Product Families

The device names, pin counts, memory sizes and peripheral availability of each family are listed in Table 1, followed by their pinout diagrams.

TABLE 1: PIC24HJ32GP202/204 AND PIC24HJ16GP304 CONTROLLER FAMILIES

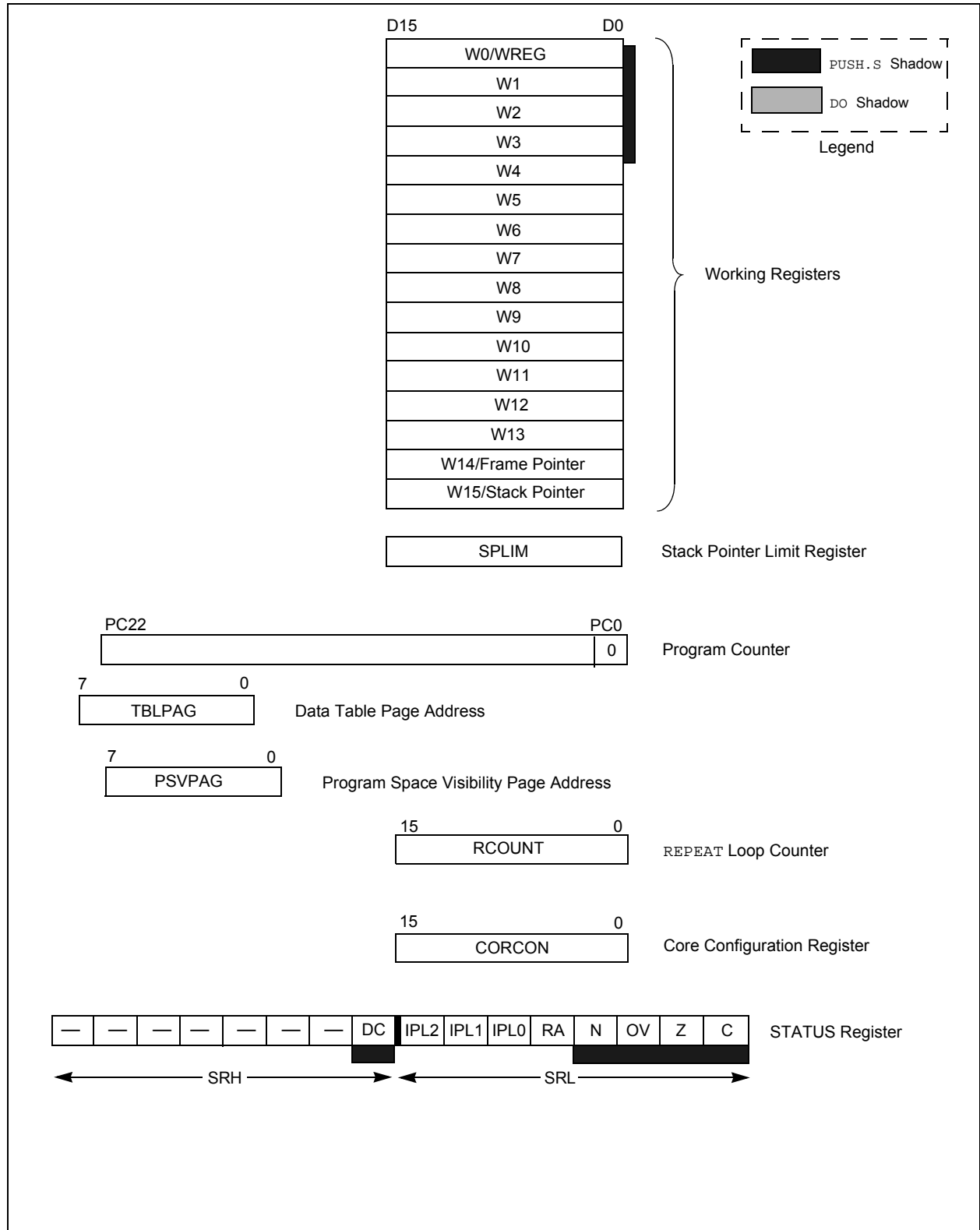
Device	Pins	Program Flash Memory (Kbytes)	RAM	Remappable Peripherals							10/12-bit ADC	I ² C™	I/O Pins (Maximum)	Packages
				Remappable Pins	16-bit Timer	Input Capture	Output Compare Standard PWM	UART	External Interrupts ⁽²⁾	SPI				
PIC24HJ32GP202	28	32	2	16	3 ⁽¹⁾	4	2	1	3	1	1 ADC, 10 ch	1	21	SPDIP SOIC SSOP QFN-S
PIC24HJ32GP204	44	32	2	26	3 ⁽¹⁾	4	2	1	3	1	1 ADC, 13 ch	1	35	QFN TQFP
PIC24HJ16GP304	44	16	2	26	3 ⁽¹⁾	4	2	1	3	1	1 ADC, 13 ch	1	35	QFN TQFP

Note 1: Only two out of three timers are remappable.

2: Only two out of three interrupts are remappable.

PIC24HJ32GP202/204 AND PIC24HJ16GP304

FIGURE 3-2: PIC24HJ32GP202/204 AND PIC24HJ16GP304 PROGRAMMER'S MODEL



PIC24HJ32GP202/204 AND PIC24HJ16GP304

REGISTER 7-3: INTCON1: INTERRUPT CONTROL REGISTER 1

R/W-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
NSTDIS	—	—	—	—	—	—	—
bit 15							bit 8

U-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0
—	DIV0ERR	—	MATHERR	ADDRERR	STKERR	OSCFAIL	—
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15 **NSTDIS:** Interrupt Nesting Disable bit

1 = Interrupt nesting is disabled

0 = Interrupt nesting is enabled

bit 14-7 **Unimplemented:** Read as '0'

bit 6 **DIV0ERR:** Arithmetic Error Status bit

1 = Math error trap was caused by a divide by zero

0 = Math error trap was not caused by a divide by zero

bit 5 **Unimplemented:** Read as '0'

bit 4 **MATHERR:** Arithmetic Error Status bit

1 = Math error trap has occurred

0 = Math error trap has not occurred

bit 3 **ADDRERR:** Address Error Trap Status bit

1 = Address error trap has occurred

0 = Address error trap has not occurred

bit 2 **STKERR:** Stack Error Trap Status bit

1 = Stack error trap has occurred

0 = Stack error trap has not occurred

bit 1 **OSCFAIL:** Oscillator Failure Trap Status bit

1 = Oscillator failure trap has occurred

0 = Oscillator failure trap has not occurred

bit 0 **Unimplemented:** Read as '0'

PIC24HJ32GP202/204 AND PIC24HJ16GP304

REGISTER 7-4: INTCON2: INTERRUPT CONTROL REGISTER 2

R/W-0	R-0	U-0	U-0	U-0	U-0	U-0	U-0
ALTIVT	DISI	—	—	—	—	—	—
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
—	—	—	—	—	INT2EP	INT1EP	INT0EP
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

- bit 15 **ALTIVT:** Enable Alternate Interrupt Vector Table bit
1 = Use alternate vector table
0 = Use standard (default) vector table
- bit 14 **DISI:** DISI Instruction Status bit
1 = DISI instruction is active
0 = DISI instruction is not active
- bit 13-3 **Unimplemented:** Read as '0'
- bit 2 **INT2EP:** External Interrupt 2 Edge Detect Polarity Select bit
1 = Interrupt on negative edge
0 = Interrupt on positive edge
- bit 1 **INT1EP:** External Interrupt 1 Edge Detect Polarity Select bit
1 = Interrupt on negative edge
0 = Interrupt on positive edge
- bit 0 **INT0EP:** External Interrupt 0 Edge Detect Polarity Select bit
1 = Interrupt on negative edge
0 = Interrupt on positive edge

PIC24HJ32GP202/204 AND PIC24HJ16GP304

REGISTER 7-18: IPC16: INTERRUPT PRIORITY CONTROL REGISTER 16

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15				bit 8			

U-0	R/W-1	R/W-0	R/W-0	U-0	U-0	U-0	U-0
—	U1EIP<2:0>			—	—	—	—
bit 7				bit 0			

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-7 **Unimplemented:** Read as '0'

bit 6-4 **U1EIP<2:0>:** UART1 Error Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•
•
•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 3-0 **Unimplemented:** Read as '0'

PIC24HJ32GP202/204 AND PIC24HJ16GP304

8.4 Clock Switching Operation

Applications are free to switch among any of the four clock sources (Primary, LP, FRC and LPRC) under software control at any time. To limit the possible side effects of this flexibility, devices have a safeguard lock built into the switch process.

Note: Primary Oscillator mode has three different submodes (XT, HS and EC), which are determined by the POSCMD<1:0> Configuration bits. While an application can switch to and from Primary Oscillator mode in software, it cannot switch among the different primary submodes without reprogramming the device.

8.4.1 ENABLING CLOCK SWITCHING

To enable clock switching, the FCKSM1 Configuration bit in the Configuration register must be programmed to '0'. (Refer to **Section 19.1 "Configuration Bits"** for further details.) If the FCKSM1 Configuration bit is unprogrammed ('1'), the clock switching function and Fail-Safe Clock Monitor function are disabled. This is the default setting.

The NOSC control bits (OSCCON<10:8>) do not control the clock selection when clock switching is disabled. However, the COSC bits (OSCCON<14:12>) reflect the clock source selected by the FNOSC Configuration bits.

The OSWEN control bit (OSCCON<0>) has no effect when clock switching is disabled. It is held at '0' at all times.

8.4.2 OSCILLATOR SWITCHING SEQUENCE

Performing a clock switch requires the following basic sequence:

1. Read the COSC bits (OSCCON<14:12>) to determine the current oscillator source, if desired.
2. Perform the unlock sequence to allow a write to the OSCCON register high byte.
3. Write the appropriate value to the NOSC control bits (OSCCON<10:8>) for the new oscillator source.
4. Perform the unlock sequence to allow a write to the OSCCON register low byte.
5. Set the OSWEN bit to initiate the oscillator switch.

Once the basic sequence is completed, the system clock hardware responds automatically as follows:

1. The clock switching hardware compares the COSC status bits with the new value of the NOSC control bits. If both of them are the same, the clock switch is a redundant operation. In this case, the OSWEN bit is cleared automatically and the clock switch is aborted.

2. If a valid clock switch has been initiated, the status bits, LOCK (OSCCON<5>) and CF (OSCCON<3>) are cleared.
3. The new oscillator is turned on by the hardware if it is not currently running. If a crystal oscillator has to be turned on, the hardware waits until the Oscillator Start-up Timer (OST) expires. If the new source is using the PLL, the hardware waits until a PLL lock is detected (LOCK = 1).
4. The hardware waits for 10 clock cycles from the new clock source and then performs the clock switch.
5. The hardware clears the OSWEN bit to indicate a successful clock transition. In addition, the NOSC bit values are transferred to the COSC status bits.
6. The old clock source is turned off at this time, with the exception of LPRC (if WDT or FSCM are enabled) or LP (if LPOSCEN remains set).

Note 1: The processor continues to execute code throughout the clock switching sequence. Timing-sensitive code should not be executed during this time.

- 2: Direct clock switches between any primary oscillator mode with PLL and FRC-PLL mode are not permitted. This applies to clock switches in either direction. In these instances, the application must switch to FRC mode as a transition clock source between the two PLL modes.

- 3: Refer to **Section 7. "Oscillator"** (DS70186) in the *"dsPIC33F/PIC24H Family Reference Manual"* for details.

8.5 Fail-Safe Clock Monitor (FSCM)

The Fail-Safe Clock Monitor (FSCM) allows the device to continue to operate even in the event of an oscillator failure. The FSCM function is enabled by programming. If the FSCM function is enabled, the LPRC internal oscillator runs at all times (except during Sleep mode) and is not subject to control by the Watchdog Timer.

In the event of an oscillator failure, the FSCM generates a clock failure trap event and switches the system clock over to the FRC oscillator. Then the application program can either attempt to restart the oscillator or execute a controlled shutdown. The trap can be treated as a warm Reset by simply loading the Reset address into the oscillator fail trap vector.

If the PLL multiplier is used to scale the system clock, the internal FRC is also multiplied by the same factor on clock failure. Essentially, the device switches to FRC with PLL on a clock failure.

PIC24HJ32GP202/204 AND PIC24HJ16GP304

9.0 POWER-SAVING FEATURES

Note 1: This data sheet summarizes the features of the PIC24HJ32GP202/204 and PIC24HJ16GP304 family of devices. However, it is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to “**Section 9. Watchdog Timer and Power Savings Modes**” (DS70196) of the “*dsPIC33F/PIC24H Family Reference Manual*”, which is available from the Microchip website (www.microchip.com).

2: Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 “Memory Organization”** in this data sheet for device-specific register and bit information.

The PIC24HJ32GP202/204 and PIC24HJ16GP304 devices provide the ability to manage power consumption by selectively managing clocking to the CPU and the peripherals. In general, a lower clock frequency and a reduction in the number of circuits being clocked constitutes lower consumed power. PIC24HJ32GP202/204 and PIC24HJ16GP304 devices can manage power consumption in four different ways:

- Clock frequency
- Instruction-based Sleep and Idle modes
- Software-controlled Doze mode
- Selective peripheral control in software

Combinations of the above methods can be used to selectively customize an application's power consumption while still maintaining critical application features, such as timing-sensitive communications.

9.1 Clock Frequency and Clock Switching

PIC24HJ32GP202/204 and PIC24HJ16GP304 devices allow a wide range of clock frequencies to be selected under application control. If the system clock configuration is not locked, users can choose low-power or high-precision oscillators by simply changing the NOSC bits (OSCCON<10:8>). The process of changing a system clock during operation, as well as limitations to the process, are discussed in more detail in **Section 8.0 “Oscillator Configuration”**.

EXAMPLE 9-1: PWRSAV INSTRUCTION SYNTAX

```
PWRSAV #SLEEP_MODE    ; Put the device into Sleep mode
PWRSAV #IDLE_MODE      ; Put the device into Idle mode
```

9.2 Instruction-Based Power-Saving Modes

PIC24HJ32GP202/204 and PIC24HJ16GP304 devices have two special power-saving modes that are entered through the execution of a special PWRSAV instruction. Sleep mode stops clock operation and halts all code execution. Idle mode halts the CPU and code execution, but allows peripheral modules to continue operation. Example 9-1 shows the Assembler syntax of the PWRSAV instruction.

Note: SLEEP_MODE and IDLE_MODE are constants defined in the assembler include file for the selected device.

Sleep and Idle modes can be exited as a result of an enabled interrupt, WDT time-out or a device Reset. When the device exits these modes, it is said to wake-up.

9.2.1 SLEEP MODE

In the Sleep mode:

- The system clock source is shut down. If an on-chip oscillator is used, it is turned off.
- The device current consumption is reduced to a minimum, provided that no I/O pin is sourcing current
- The Fail-Safe Clock Monitor does not operate, since the system clock source is disabled
- The LPRC clock continues to run if the WDT is enabled
- The WDT, if enabled, is automatically cleared prior to entering Sleep mode
- Some device features or peripherals may continue to operate. This includes items such as the input change notification on the I/O ports, or peripherals that use an external clock input.
- Any peripheral that requires the system clock source for its operation is disabled

The device will wake-up from Sleep mode on any of these events:

- Any interrupt source that is individually enabled
- Any form of device Reset
- A WDT time-out

On wake-up from Sleep mode, the processor restarts with the same clock source that was active when Sleep mode was entered.

PIC24HJ32GP202/204 AND PIC24HJ16GP304

REGISTER 9-2: PMD2: PERIPHERAL MODULE DISABLE CONTROL REGISTER 2

R/W-0	R/W-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0
IC8MD	IC7MD	—	—	—	—	IC2MD	IC1MD
bit 15						bit 8	
U-0	U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0
—	—	—	—	—	—	OC2MD	OC1MD
bit 7						bit 0	

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

- bit 15 **IC8MD:** Input Capture 8 Module Disable bit
 1 = Input Capture 8 module is disabled
 0 = Input Capture 8 module is enabled
- bit 14 **IC7MD:** Input Capture 2 Module Disable bit
 1 = Input Capture 7 module is disabled
 0 = Input Capture 7 module is enabled
- bit 13-10 **Unimplemented:** Read as '0'
- bit 9 **IC2MD:** Input Capture 2 Module Disable bit
 1 = Input Capture 2 module is disabled
 0 = Input Capture 2 module is enabled
- bit 8 **IC1MD:** Input Capture 1 Module Disable bit
 1 = Input Capture 1 module is disabled
 0 = Input Capture 1 module is enabled
- bit 7-2 **Unimplemented:** Read as '0'
- bit 1 **OC2MD:** Output Compare 2 Module Disable bit
 1 = Output Compare 2 module is disabled
 0 = Output Compare 2 module is enabled
- bit 0 **OC1MD:** Output Compare 1 Module Disable bit
 1 = Output Compare 1 module is disabled
 0 = Output Compare 1 module is enabled

PIC24HJ32GP202/204 AND PIC24HJ16GP304

TABLE 10-1: REMAPPABLE PERIPHERAL INPUTS⁽¹⁾

Input Name	Function Name	Register	Configuration Bits
External Interrupt 1	INT1	RPINR0	INT1R<4:0>
External Interrupt 2	INT2	RPINR1	INT2R<4:0>
Timer 2 External Clock	T2CK	RPINR3	T2CKR<4:0>
Timer 3 External Clock	T3CK	RPINR3	T3CKR<4:0>
Input Capture 1	IC1	RPINR7	IC1R<4:0>
Input Capture 2	IC2	RPINR7	IC2R<4:0>
Input Capture 7	IC7	RPINR10	IC7R<4:0>
Input Capture 8	IC8	RPINR10	IC8R<4:0>
Output Compare Fault A	OCFA	RPINR11	OCFA<4:0>
UART 1 Receive	U1RX	RPINR18	U1RXR<4:0>
UART 1 Clear To Send	U1CTS	RPINR18	U1CTS<4:0>
SPI 1 Data Input	SDI1	RPINR20	SDI1R<4:0>
SPI 1 Clock Input	SCK1IN	RPINR20	SCK1R<4:0>
SPI 1 Slave Select Input	SS1IN	RPINR21	SS1R<4:0>

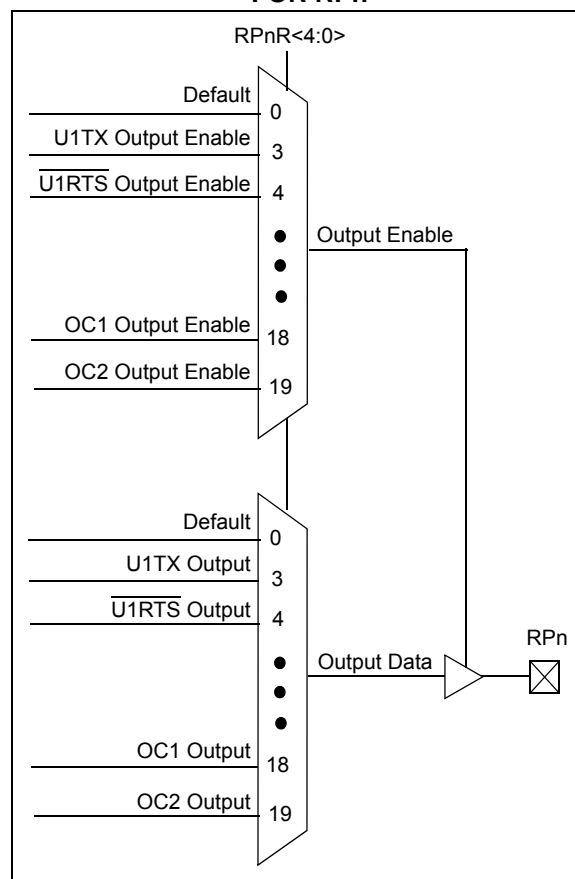
Note 1: Unless otherwise noted, all inputs use the Schmitt input buffers.

10.6.2.2 Output Mapping

In contrast to inputs, the outputs of the peripheral pin select options are mapped on the basis of the pin. In this case, a control register associated with a particular pin dictates the peripheral output to be mapped. The RPORx registers are used to control output mapping. Like the RPINRx registers, each register contains sets of 5-bit fields, with each set associated with one RPN pin (see Register 10-10 through Register 10-22). The value of the bit field corresponds to one of the peripherals, and that peripheral's output is mapped to the pin (see Table 10-2 and Figure 10-3).

The list of peripherals for output mapping also includes a null value of '00000' because of the mapping technique. This permits any given pin to remain unconnected from the output of any of the pin selectable peripherals.

FIGURE 10-3: MULTIPLEXING OF REMAPPABLE OUTPUT FOR RPN



PIC24HJ32GP202/204 AND PIC24HJ16GP304

14.0 OUTPUT COMPARE

Note 1: This data sheet summarizes the features of the PIC24HJ32GP202/204 and PIC24HJ16GP304 family of devices. However, it is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to “**Section 13. Output Compare**” (DS70209) of the “dsPIC33F/PIC24H Family Reference Manual”, which is available from the Microchip website (www.microchip.com).

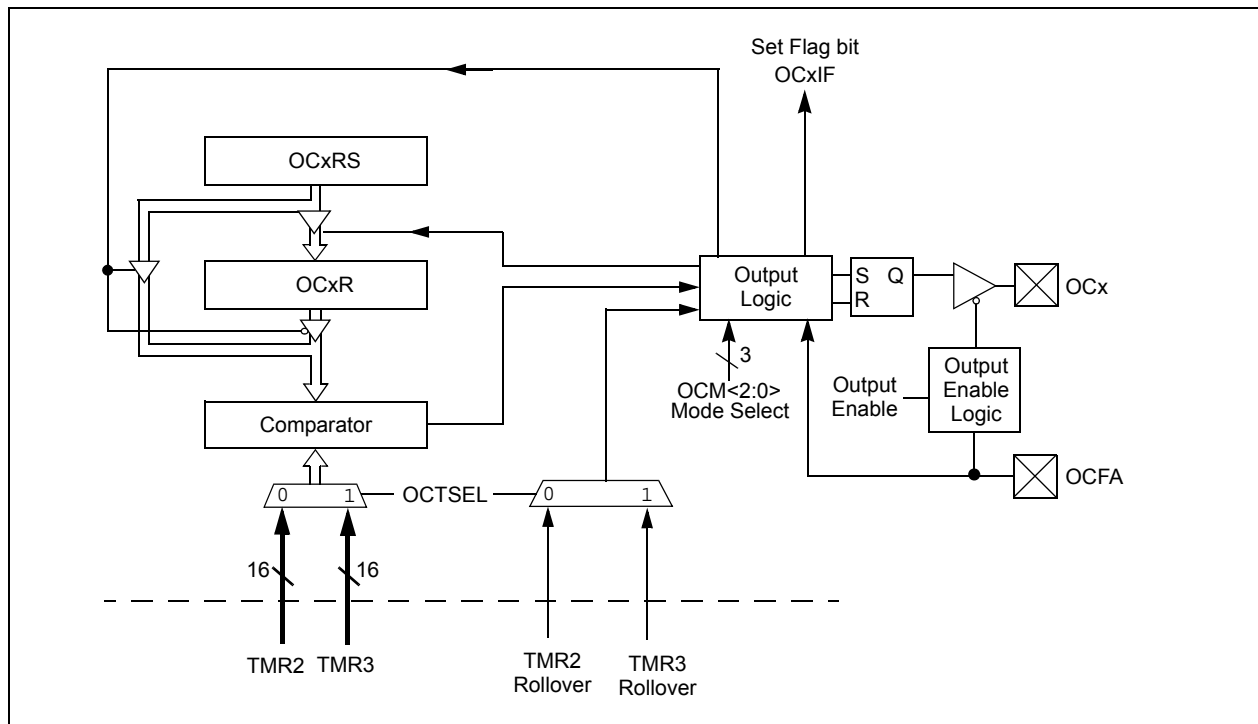
2: Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 “Memory Organization”** in this data sheet for device-specific register and bit information.

The Output Compare module can select either Timer2 or Timer3 for its time base. The module compares the value of the timer with the value of one or two compare registers depending on the operating mode selected. The state of the output pin changes when the timer value matches the compare register value. The Output Compare module generates either a single output pulse or a sequence of output pulses, by changing the state of the output pin on the compare match events. The Output Compare module can also generate interrupts on compare match events.

The Output Compare module has multiple operating modes:

- Active-Low One-Shot mode
- Active-High One-Shot mode
- Toggle mode
- Delayed One-Shot mode
- Continuous Pulse mode
- PWM mode without fault protection
- PWM mode with fault protection

FIGURE 14-1: OUTPUT COMPARE MODULE BLOCK DIAGRAM



PIC24HJ32GP202/204 AND PIC24HJ16GP304

REGISTER 15-2: SPIxCON1: SPIx CONTROL REGISTER 1 (CONTINUED)

bit 4-2 **SPRE<2:0>**: Secondary Prescale bits (Master mode)⁽³⁾

111 = Secondary prescale 1:1

110 = Secondary prescale 2:1

•

•

•

000 = Secondary prescale 8:1

bit 1-0 **PPRE<1:0>**: Primary Prescale bits (Master mode)⁽³⁾

11 = Primary prescale 1:1

10 = Primary prescale 4:1

01 = Primary prescale 16:1

00 = Primary prescale 64:1

Note 1: The CKE bit is not used in the Framed SPI modes. Program this bit to '0' for the Framed SPI modes (FRMEN = 1).

2: This bit must be cleared when FRMEN = 1.

3: Do not set both Primary and Secondary prescalers to a value of 1:1.

PIC24HJ32GP202/204 AND PIC24HJ16GP304

17.1 UART Helpful Tips

1. In multi-node direct-connect UART networks, UART receive inputs react to the complementary logic level defined by the URXINV bit (UxMODE<4>), which defines the idle state, the default of which is logic high, (i.e., URXINV = 0). Because remote devices do not initialize at the same time, it is likely that one of the devices, because the RX line is floating, will trigger a start bit detection and will cause the first byte received after the device has been initialized to be invalid. To avoid this situation, the user should use a pull-up or pull-down resistor on the RX pin depending on the value of the URXINV bit.
 - a) If URXINV = 0, use a pull-up resistor on the RX pin.
 - b) If URXINV = 1, use a pull-down resistor on the RX pin.
2. The first character received on a wake-up from Sleep mode caused by activity on the UxRX pin of the UART module will be invalid. In Sleep mode, peripheral clocks are disabled. By the time the oscillator system has restarted and stabilized from Sleep mode, the baud rate bit sampling clock relative to the incoming UxRX bit timing is no longer synchronized, resulting in the first character being invalid. This is to be expected.

17.2 UART Resources

Many useful resources are provided on the main product page of the Microchip web site for the devices listed in this data sheet. This product page, which can be accessed using this link, contains the latest updates and additional information.

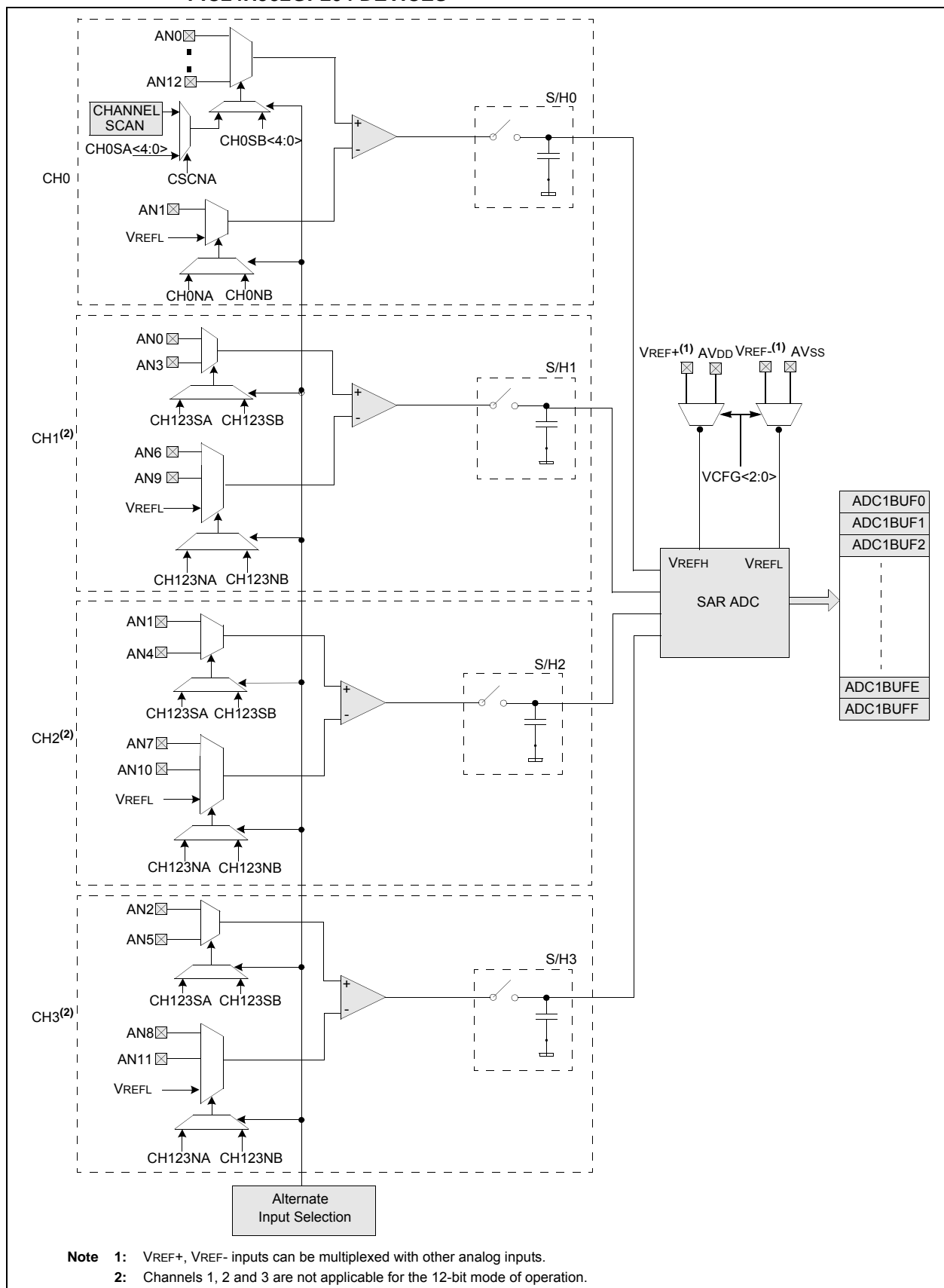
Note: In the event you are not able to access the product page using the link above, enter this URL in your browser: http://www.microchip.com/wwwproducts/Devices.aspx?dDocName=en530271
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17.2.1 KEY RESOURCES

- **Section 17. “UART” (DS70188)**
- Code Samples
- Application Notes
- Software Libraries
- Webinars
- All related dsPIC33F/PIC24H Family Reference Manuals Sections
- Development Tools

PIC24HJ32GP202/204 AND PIC24HJ16GP304

FIGURE 18-1: ADC1 MODULE BLOCK DIAGRAM FOR PIC24HFJ16GP304 AND PIC24HJ32GP204 DEVICES



PIC24HJ32GP202/204 AND PIC24HJ16GP304

19.4 Watchdog Timer (WDT)

For PIC24HJ32GP202/204 and PIC24HJ16GP304 devices, the WDT is driven by the LPRC oscillator. When the WDT is enabled, the clock source is also enabled.

19.4.1 PRESCALER/POSTSCALER

The nominal WDT clock source from LPRC is 32 kHz. This feeds a prescaler that can be configured for either 5-bit (divide-by-32) or 7-bit (divide-by-128) operation. The prescaler is set by the WDTPRE Configuration bit. With a 32 kHz input, the prescaler yields a nominal WDT time-out period (T_{WDT}) of 1 ms in 5-bit mode, or 4 ms in 7-bit mode.

A variable postscaler divides down the WDT prescaler output and allows for a wide range of time-out periods. The postscaler is controlled by the WDTPOST<3:0> Configuration bits (FWDEN<3:0>), which allows the selection of 16 settings, from 1:1 to 1:32,768. Using the prescaler and postscaler, time-out periods ranging from 1 ms to 131 seconds can be achieved.

The WDT, prescaler and postscaler are reset:

- On any device Reset
- On the completion of a clock switch, whether invoked by software (i.e., setting the OSWEN bit after changing the NOSC bits) or by hardware (i.e., Fail-Safe Clock Monitor)
- When a PWRSAV instruction is executed (Sleep or Idle mode is entered)
- When the device exits Sleep or Idle mode to resume normal operation
- By a CLRWDT instruction during normal execution

Note: The CLRWDT and PWRSAV instructions clear the prescaler and postscaler counts when executed.

19.4.2 SLEEP AND IDLE MODES

If the WDT is enabled, it will continue to run during Sleep or Idle modes. When the WDT time-out occurs, the device will wake the device and code execution will continue from where the PWRSAV instruction was executed. The corresponding SLEEP or IDLE bits (RCON<3,2>) will need to be cleared in software after the device wakes up.

19.4.3 ENABLING WDT

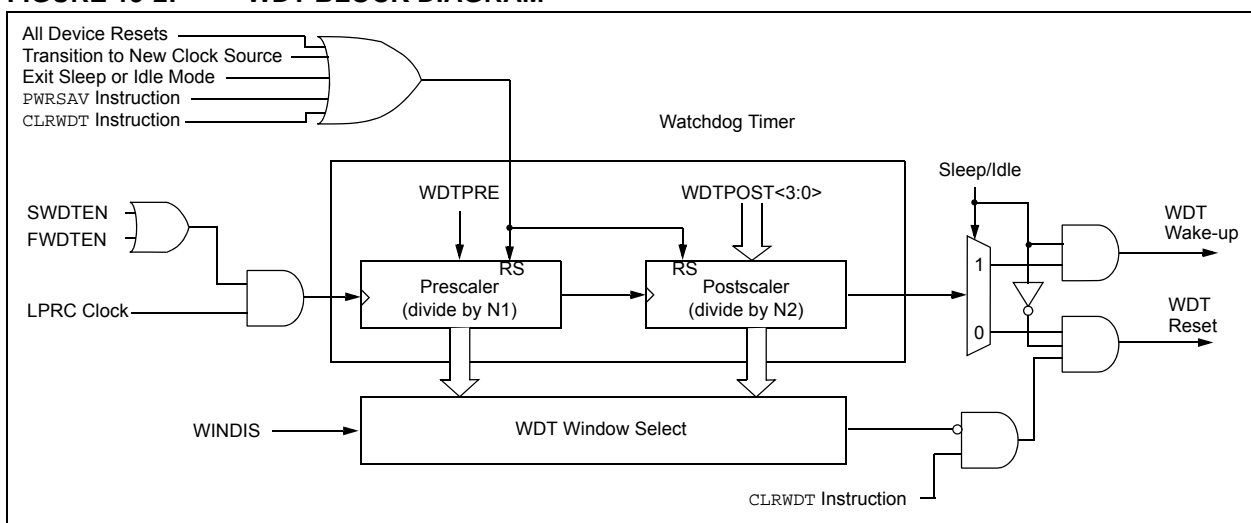
The WDT is enabled or disabled by the FWDEN Configuration bit in the FWDT Configuration register. When the FWDEN Configuration bit is set, the WDT is always enabled.

The WDT flag bit, WDTO (RCON<4>), is not automatically cleared following a WDT time-out. To detect subsequent WDT events, the flag must be cleared in software.

The WDT can be optionally controlled in software when the FWDEN Configuration bit has been programmed to '0'. The WDT is enabled in software by setting the SWDTEN control bit (RCON<5>). The SWDTEN control bit is cleared on any device Reset. The software WDT option allows the user application to enable the WDT for critical code segments and disable the WDT during non-critical segments for maximum power savings.

Note: If the WINDIS bit (FWDEN<6>) is cleared, the CLRWDT instruction should be executed by the application software only during the last 1/4 of the WDT period. This CLRWDT window can be determined by using a timer. If a CLRWDT instruction is executed before this window, a WDT Reset occurs.

FIGURE 19-2: WDT BLOCK DIAGRAM



PIC24HJ32GP202/204 AND PIC24HJ16GP304

NOTES:

21.0 DEVELOPMENT SUPPORT

The PIC® microcontrollers and dsPIC® digital signal controllers are supported with a full range of software and hardware development tools:

- Integrated Development Environment
 - MPLAB® IDE Software
- Compilers/Assemblers/Linkers
 - MPLAB C Compiler for Various Device Families
 - HI-TECH C® for Various Device Families
 - MPASM™ Assembler
 - MPLINK™ Object Linker/
MPLIB™ Object Librarian
 - MPLAB Assembler/Linker/Librarian for Various Device Families
- Simulators
 - MPLAB SIM Software Simulator
- Emulators
 - MPLAB REAL ICE™ In-Circuit Emulator
- In-Circuit Debuggers
 - MPLAB ICD 3
 - PICKit™ 3 Debug Express
- Device Programmers
 - PICKit™ 2 Programmer
 - MPLAB PM3 Device Programmer
- Low-Cost Demonstration/Development Boards, Evaluation Kits, and Starter Kits

21.1 MPLAB Integrated Development Environment Software

The MPLAB IDE software brings an ease of software development previously unseen in the 8/16/32-bit microcontroller market. The MPLAB IDE is a Windows® operating system-based application that contains:

- A single graphical interface to all debugging tools
 - Simulator
 - Programmer (sold separately)
 - In-Circuit Emulator (sold separately)
 - In-Circuit Debugger (sold separately)
- A full-featured editor with color-coded context
- A multiple project manager
- Customizable data windows with direct edit of contents
- High-level source code debugging
- Mouse over variable inspection
- Drag and drop variables from source to watch windows
- Extensive on-line help
- Integration of select third party tools, such as IAR C Compilers

The MPLAB IDE allows you to:

- Edit your source files (either C or assembly)
- One-touch compile or assemble, and download to emulator and simulator tools (automatically updates all project information)
- Debug using:
 - Source files (C or assembly)
 - Mixed C and assembly
 - Machine code

MPLAB IDE supports multiple debugging tools in a single development paradigm, from the cost-effective simulators, through low-cost in-circuit debuggers, to full-featured emulators. This eliminates the learning curve when upgrading to tools with increased flexibility and power.

21.7 MPLAB SIM Software Simulator

The MPLAB SIM Software Simulator allows code development in a PC-hosted environment by simulating the PIC MCUs and dsPIC® DSCs on an instruction level. On any given instruction, the data areas can be examined or modified and stimuli can be applied from a comprehensive stimulus controller. Registers can be logged to files for further run-time analysis. The trace buffer and logic analyzer display extend the power of the simulator to record and track program execution, actions on I/O, most peripherals and internal registers.

The MPLAB SIM Software Simulator fully supports symbolic debugging using the MPLAB C Compilers, and the MPASM and MPLAB Assemblers. The software simulator offers the flexibility to develop and debug code outside of the hardware laboratory environment, making it an excellent, economical software development tool.

21.8 MPLAB REAL ICE In-Circuit Emulator System

MPLAB REAL ICE In-Circuit Emulator System is Microchip's next generation high-speed emulator for Microchip Flash DSC and MCU devices. It debugs and programs PIC® Flash MCUs and dsPIC® Flash DSCs with the easy-to-use, powerful graphical user interface of the MPLAB Integrated Development Environment (IDE), included with each kit.

The emulator is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with either a connector compatible with in-circuit debugger systems (RJ11) or with the new high-speed, noise tolerant, Low-Voltage Differential Signal (LVDS) interconnection (CAT5).

The emulator is field upgradable through future firmware downloads in MPLAB IDE. In upcoming releases of MPLAB IDE, new devices will be supported, and new features will be added. MPLAB REAL ICE offers significant advantages over competitive emulators including low-cost, full-speed emulation, run-time variable watches, trace analysis, complex breakpoints, a ruggedized probe interface and long (up to three meters) interconnection cables.

21.9 MPLAB ICD 3 In-Circuit Debugger System

MPLAB ICD 3 In-Circuit Debugger System is Microchip's most cost effective high-speed hardware debugger/programmer for Microchip Flash Digital Signal Controller (DSC) and microcontroller (MCU) devices. It debugs and programs PIC® Flash microcontrollers and dsPIC® DSCs with the powerful, yet easy-to-use graphical user interface of MPLAB Integrated Development Environment (IDE).

The MPLAB ICD 3 In-Circuit Debugger probe is connected to the design engineer's PC using a high-speed USB 2.0 interface and is connected to the target with a connector compatible with the MPLAB ICD 2 or MPLAB REAL ICE systems (RJ-11). MPLAB ICD 3 supports all MPLAB ICD 2 headers.

21.10 PICKit 3 In-Circuit Debugger/Programmer and PICKit 3 Debug Express

The MPLAB PICKit 3 allows debugging and programming of PIC® and dsPIC® Flash microcontrollers at a most affordable price point using the powerful graphical user interface of the MPLAB Integrated Development Environment (IDE). The MPLAB PICKit 3 is connected to the design engineer's PC using a full speed USB interface and can be connected to the target via an Microchip debug (RJ-11) connector (compatible with MPLAB ICD 3 and MPLAB REAL ICE). The connector uses two device I/O pins and the reset line to implement in-circuit debugging and In-Circuit Serial Programming™.

The PICKit 3 Debug Express include the PICKit 3, demo board and microcontroller, hookup cables and CDROM with user's guide, lessons, tutorial, compiler and MPLAB IDE software.

PIC24HJ32GP202/204 AND PIC24HJ16GP304

TABLE 22-10: DC CHARACTERISTICS: I/O PIN OUTPUT SPECIFICATIONS

DC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for Industrial $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for Extended				
Param.	Symbol	Characteristic	Min.	Typ.	Max.	Units	Conditions
DO10	VOL	Output Low Voltage I/O Pins: 2x Sink Driver Pins - All pins not defined by 4x or 8x driver pins	—	—	0.4	V	$I_{OL} \leq 3 \text{ mA}$, $V_{DD} = 3.3\text{V}$
		Output Low Voltage I/O Pins: 4x Sink Driver Pins - RA0, RA1, RB5, RB6, RB8, RB9, RB14	—	—	0.4	V	$I_{OL} \leq 6 \text{ mA}$, $V_{DD} = 3.3\text{V}$
		Output Low Voltage I/O Pins: 8x Sink Driver Pins - OSCO, CLKO, RA3	—	—	0.4	V	$I_{OL} \leq 10 \text{ mA}$, $V_{DD} = 3.3\text{V}$
DO20	VOH	Output High Voltage I/O Pins: 2x Source Driver Pins - All pins not defined by 4x or 8x driver pins	2.4	—	—	V	$I_{OH} \geq -3 \text{ mA}$, $V_{DD} = 3.3\text{V}$
		Output High Voltage I/O Pins: 4x Source Driver Pins - RA0, RA1, RB5, RB6, RB8, RB9, RB14	2.4	—	—	V	$I_{OH} \geq -6 \text{ mA}$, $V_{DD} = 3.3\text{V}$
		Output High Voltage I/O Pins: 8x Source Driver Pins - OSCO, CLKO, RA3	2.4	—	—	V	$I_{OH} \geq -10 \text{ mA}$, $V_{DD} = 3.3\text{V}$
DO20A	VOH1	Output High Voltage I/O Pins: 2x Source Driver Pins - All pins not defined by 4x or 8x driver pins	1.5	—	—	V	$I_{OH} \geq -6 \text{ mA}$, $V_{DD} = 3.3\text{V}$ See Note 1
			2.0	—	—		$I_{OH} \geq -5 \text{ mA}$, $V_{DD} = 3.3\text{V}$ See Note 1
			3.0	—	—		$I_{OH} \geq -2 \text{ mA}$, $V_{DD} = 3.3\text{V}$ See Note 1
		Output High Voltage 4x Source Driver Pins - RA0, RA1, RB5, RB6, RB8, RB9, RB14	1.5	—	—	V	$I_{OH} \geq -12 \text{ mA}$, $V_{DD} = 3.3\text{V}$ See Note 1
			2.0	—	—		$I_{OH} \geq -11 \text{ mA}$, $V_{DD} = 3.3\text{V}$ See Note 1
			3.0	—	—		$I_{OH} \geq -3 \text{ mA}$, $V_{DD} = 3.3\text{V}$ See Note 1
		Output High Voltage 8x Source Driver Pins - OSCO, CLKO, RA3	1.5	—	—	V	$I_{OH} \geq -16 \text{ mA}$, $V_{DD} = 3.3\text{V}$ See Note 1
			2.0	—	—		$I_{OH} \geq -12 \text{ mA}$, $V_{DD} = 3.3\text{V}$ See Note 1
			3.0	—	—		$I_{OH} \geq -4 \text{ mA}$, $V_{DD} = 3.3\text{V}$ See Note 1

Note 1: Parameters are characterized, but not tested.

PIC24HJ32GP202/204 AND PIC24HJ16GP304

FIGURE 22-17: I2Cx BUS START/STOP BITS TIMING CHARACTERISTICS (MASTER MODE)

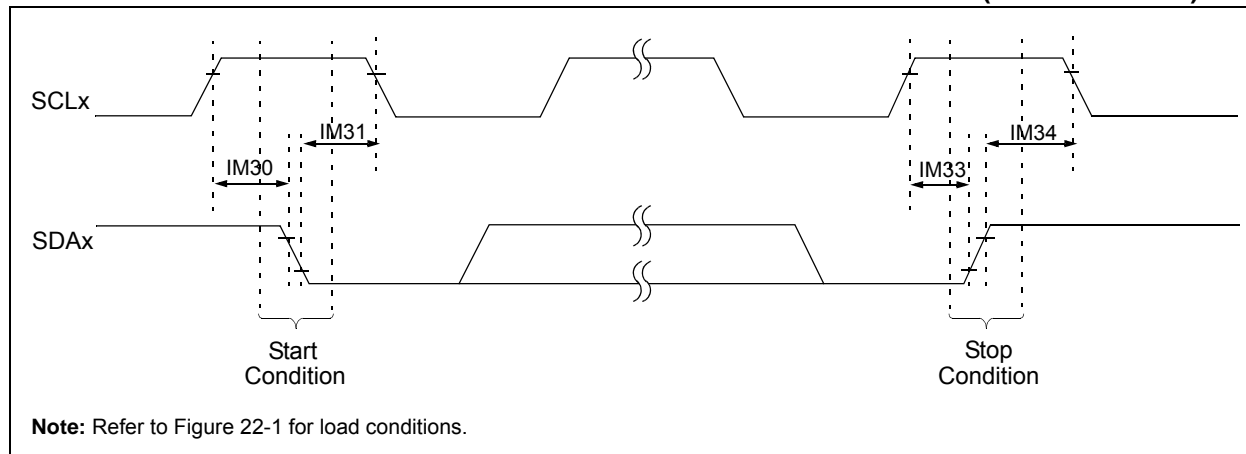
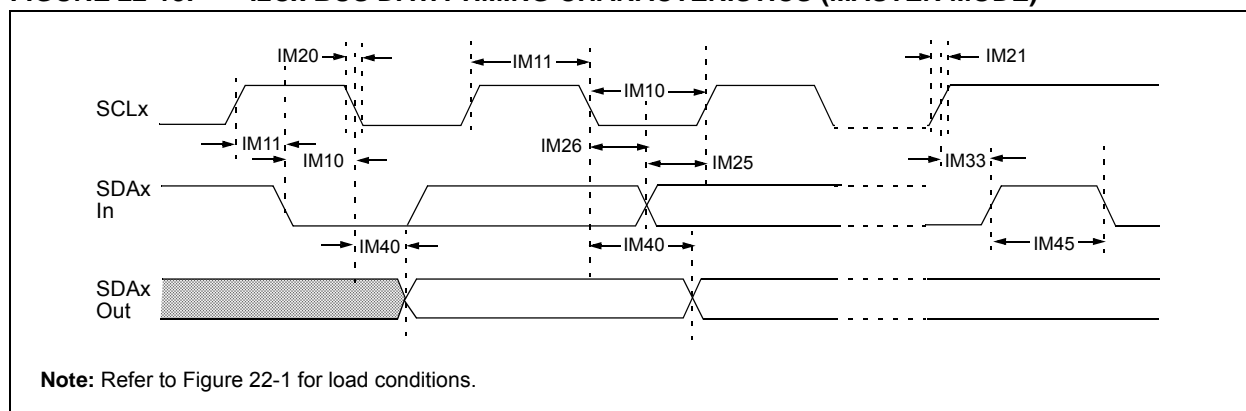


FIGURE 22-18: I2Cx BUS DATA TIMING CHARACTERISTICS (MASTER MODE)



PIC24HJ32GP202/204 AND PIC24HJ16GP304

TABLE 25-1: MAJOR SECTION UPDATES (CONTINUED)

Section Name	Update Description
Section 18.0 “Special Features”	<p>Added FICD register information for address 0xF8000E in the Device Configuration Register Map (see Table 18-1).</p> <p>Added FICD register content (BKBUG, COE, JTAGEN, and ICS<1:0> to the PIC24HJ32GP202/204 and PIC24HJ16GP304 Configuration Bits Description (see Table 18-2).</p> <p>Added a note regarding the placement of low-ESR capacitors, after the second paragraph of Section 18.2 “On-Chip Voltage Regulator” and to Figure 18-1.</p> <p>Removed the words “if enabled” from the second sentence in the fifth paragraph of Section 18.3 “BOR: Brown-Out Reset”.</p>
Section 21.0 “Electrical Characteristics”	<p>Removed Typ value for parameter DC12 (see Table 21-4).</p> <p>Updated MIPS conditions for parameters DC24c, DC44c, DC72a, DC72f and DC72g (see Table 21-5, Table 21-6 and Table 21-8).</p> <p>Added Note 4 (reference to new table containing digital-only and analog pin information to I/O Pin Input Specifications (see Table 21-9).</p> <p>Updated Min, Typ, and Max values and updated Min values for Program Memory parameters D136, D137 and D138 (see Table 21-12).</p> <p>Updated Max value for Internal RC Accuracy parameter F21 for $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ condition and added Note 2 (see Table 21-19).</p> <p>Removed all values for Reset, Watchdog Timer, Oscillator Start-up Timer, and Power-up Timer parameter SY20 and updated conditions, which now refers to Section 18.4 “Watchdog Timer (WDT)” and LPRC parameter F21 (see Table 21-21).</p> <p>Updated Min and Typ values for parameters AD60, AD61, AD62 and AD63 and removed Note 3 (see Table 21-37).</p> <p>Updated Min and Typ values for parameters AD60, AD61, AD62 and AD63 and removed Note 3 (see Table 21-38).</p>